

30V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
30V	$22m\Omega$ @ V_{GS} = $10V$	6.7A
	$30m\Omega$ @ $V_{GS} = 4.5V$	5.2A

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{\mathrm{DS(ON)}})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

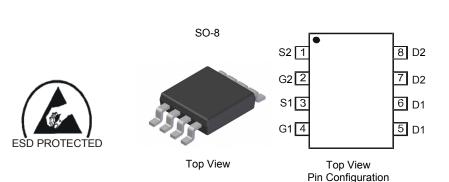
- Backlighting
- Power Management Functions
- DC-DC Converters

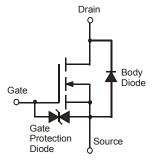
Features

- Low On-Resistance
- 100% UIS (Avalanche) Rated
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.008 grams (approximate)





Equivalent Circuit per Element

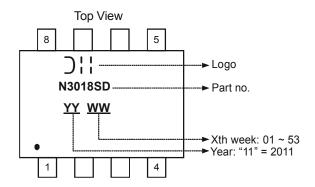
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3018SSD-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units	
Drain-Source Voltage			V_{DSS}	30	V	
Gate-Source Voltage			V _{GSS}	±20	V	
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	I _D	6.7 5.3	А	
	t < 10s	T _A = +25°C T _A = +70°C	I _D	8.7 6.9	А	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	60	Α	
Maximum Body Diode continuous Current			I _S	2.0	А	
Avalanche Current (Note 6) L = 0.1mH			I _{AR}	19	Α	
Repetitive Avalanche Energy (Note 6) L = 0.1mH			E _{AR}	18	mJ	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

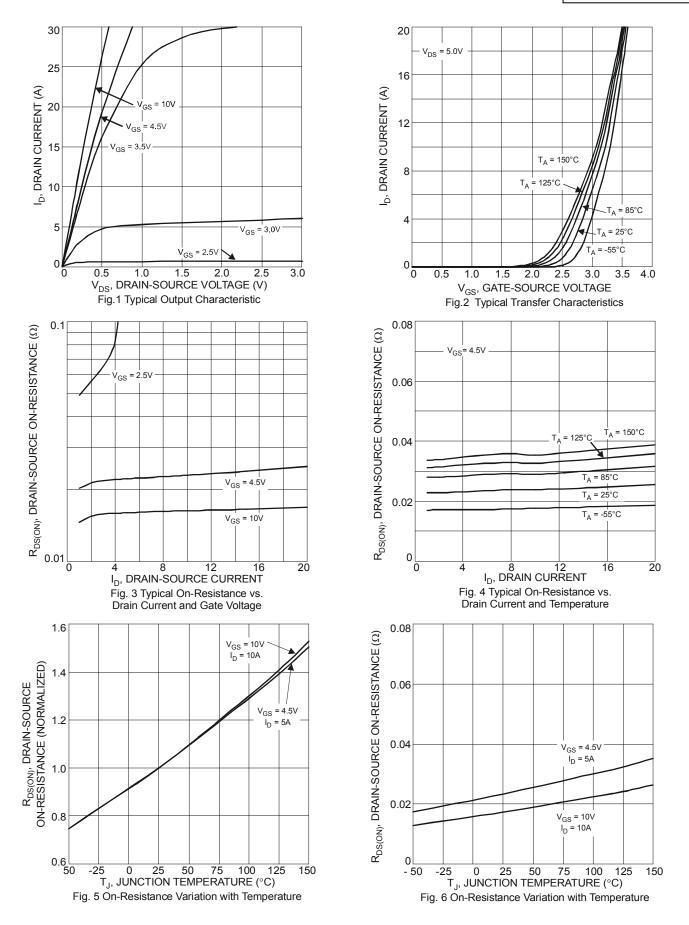
Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 5)		P_{D}	1.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	Г	83	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{\theta JA}$	50	°C/W
Thermal Resistance, Junction to Case (Note 5)	R _{0JC}	14.5	°C/W	
Operating and Storage Temperature Range		$T_{J_{I}}T_{STG}$	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

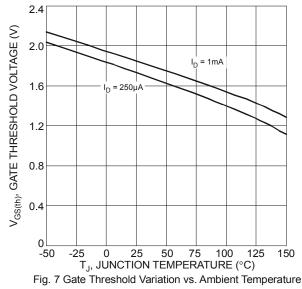
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	1		V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I_{DSS}	_		1	μΑ	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(th)}$	1	1.7	2.1	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	16	22	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Drain-Source On-Resistance	R _{DS} (ON)	_	23	30	11122	$V_{GS} = 4.5V, I_D = 6A$	
Forward Transfer Admittance	Y _{fs}	_	8.3	_	S	$V_{DS} = 5V, I_{D} = 6.9A$	
Diode Forward Voltage	V_{SD}	0.5		1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	697	_		V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	97	_	pF		
Reverse Transfer Capacitance	C_{rss}	_	67	_			
Gate resistance	R_g	_	1.47		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	6.0	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	13.2		nC	$V_{GS} = 10V, V_{DS} = 15V,$ $I_D = 9A$	
Gate-Source Charge	Q_{gs}	_	2.2	_	IIC		
Gate-Drain Charge	Q_{gd}	_	1.8	_			
Turn-On Delay Time	t _{D(on)}	_	4.3	_		V_{DD} = 15V, V_{GS} = 10V, R_{L} = 15 Ω , I_{D} = 1A, R_{G} = 6 Ω	
Turn-On Rise Time	t _r	_	4.4	_			
Turn-Off Delay Time	$t_{D(off)}$	_	20.1	_	ns		
Turn-Off Fall Time	Ì _f	_	4.1	_		1	
Reverse Recovery Time	t _{rr}	_	7.3	_	ns	L 0.4 divide 500.4/	
Reverse Recovery Charge	Q _{rr}	_	7.9	_	nC	I _F = 9A, di/dt = 500A/μs	

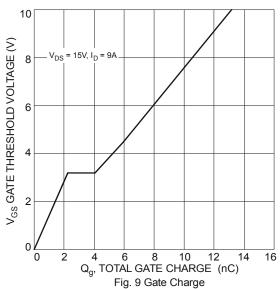
5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 6. I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep T_J = +25°C 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

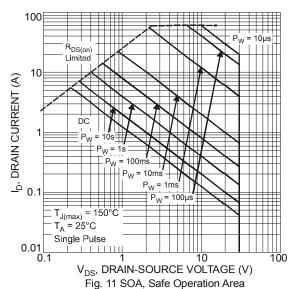


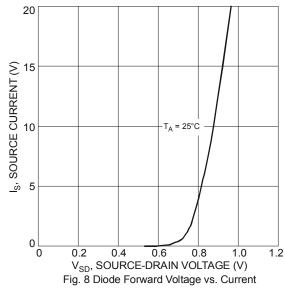


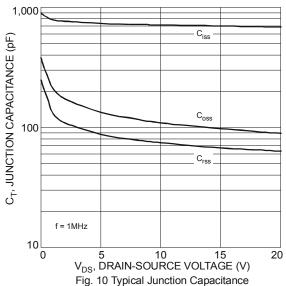




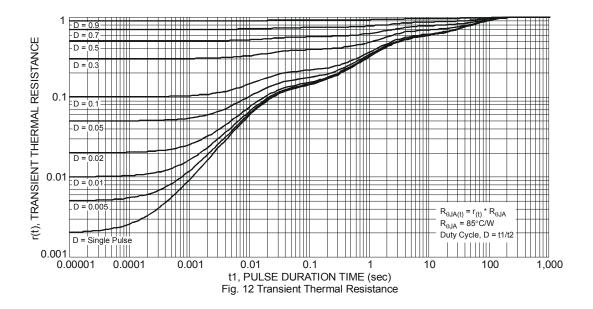






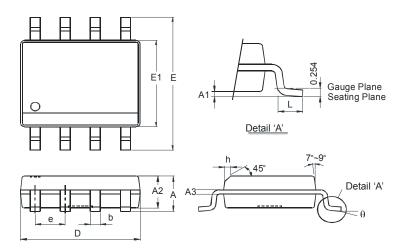






Package Outline Dimensions

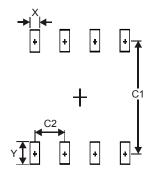
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85	3.95			
e	e 1.27 Typ				
h	1	0.35			
L	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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